

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3440754

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| SUBMISSION TYPE: | NEW ASSIGNMENT |
| NATURE OF CONVEYANCE: | ASSIGNMENT |
| CONVEYING PARTY DATA | |
| Name | Execution Date |
| AMIT PAUL | 08/13/2009 |
| MOHAMED N. DARWISH | 01/05/2012 |
| RECEIVING PARTY DATA | |
| Name: | MAXPOWER SEMICONDUCTOR INC. |
| Street Address: | 181 METRO DRIVE |
| Internal Address: | SUITE 590 |
| City: | SAN JOSE |
| State/Country: | CALIFORNIA |
| Postal Code: | 95110 |
| PROPERTY NUMBERS Total: 1 | |
| Property Type | Number |
| Application Number: | 12431005 |
| CORRESPONDENCE DATA | |
| Fax Number: | (214)206-9992 |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> | |
| Phone: | 4695563578 |
| Email: | ggroover@technopatents.com |
| Correspondent Name: | GWENDOLYN S.S. GROOVER |
| Address Line 1: | 121 W. SOUTH COMMERCE ST. |
| Address Line 4: | WILLS POINT, TEXAS 75169 |
| ATTORNEY DOCKET NUMBER: | MXP-021 |
| NAME OF SUBMITTER: | GWENDOLYN S.S. GROOVER |
| SIGNATURE: | /Gwendolyn S.S. Groover/ |
| DATE SIGNED: | 07/15/2015 |
| Total Attachments: 4 | |
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ASSIGNMENT

This ASSIGNMENT is made and entered into, as of the date set forth below, by the undersigned in favor of MaxPower Semiconductor Inc., a corporation organized under the laws of California and having its principal place of business at 675 Regas Drive, Campbell CA 95008 ("Assignee").

WITNESSETH:

NOW, THEREFORE, in consideration of the premises and the mutual promises set forth herein, and for other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby agrees as follows:


1. The undersigned does hereby assign and transfer to Assignee, its successors, assigns and legal representatives, the entire right, title and interest in and to any and all inventions which are described in the application for United States Patent identified below and to any and all improvements thereto.
2. The undersigned does hereby assign and transfer to Assignee the entire right, title and interest to all applications (including provisional, divisionals, continuations, substitutions, reissues, and extensions), which have been or shall be filed in the United States and all foreign countries and under the terms of any treaties or conventions (including the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, and the European Patent Convention) relating to said invention and any of said improvements; and in and to all rights of priority resulting from the filing of any such applications.
3. The undersigned agrees that Assignee may apply for and receive patents for said invention and improvements in its own name; and that, when requested, without charge to, but at the expense of, Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this Assignment, the undersigned will execute all provisional, divisional, continuations, substitutions, reissues, extensions, and all other patent applications on any and all said improvements; execute all rightful oaths, declarations, assignments, powers of attorney and other papers; communicate to Assignee, its successors, assigns, and representatives, all facts known to undersigned relating to said inventions and improvements and the history thereof; and generally do everything possible which Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said inventions and improvements, and for vesting title to said invention and improvements, and all applications for patents and all patents on said invention and improvements, in Assignee, its successors, assigns and legal representatives.
4. The undersigned represents and warrants to Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

The Application for U.S. Patent entitled *Semiconductor on Insulator Devices Containing Permanent Charge*

- ☐ has been executed by the undersigned on _____, ____.
- ☐ has been executed by the undersigned concurrently herewith.
- ☒ was filed on April 28, 2009, and assigned Serial No. 12/431,005.

This Assignment also includes U.S. Provisional Application No. 61/084,639, filed 07/30/2008, entitled *Lateral Devices Containing Permanent Charge* and U.S. Provisional Application No. 61/084,642, filed 07/30/2008, entitled *Silicon on Insulator Devices Containing Permanent Charge*.

IN WITNESS WHEREOF, the undersigned has duly executed this Assignment on the date indicated below:

Signature: 
Amit Paul
455 Crescent Ave
#34
Sunnyvale CA 94087

Date: August 13, 2009

Signature: _____
Mohamed N. Darwish
675 Regas Drive
Campbell CA 95008 USA

Date: _____

ASSIGNMENT

As a below-named inventor of the U.S. patent application entitled SEMICONDUCTOR ON INSULATOR DEVICES CONTAINING PERMANENT CHARGE, with U.S. Application number 12/431,005, filed April 28, 2009, I hereby sell, assign and transfer to MAXPOWER SEMICONDUCTOR INC. (hereinafter referred to as ASSIGNEE), for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the full and exclusive right, title, and interest to said invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in all foreign countries to be obtained for said invention by said application or any division, continuation, continuation-in-part, renewal, substitute, extension, re-examination or reissue thereof or any legal equivalent thereof in the United States or any foreign country or national or regional patent authority, for the full term or terms of which the same may be granted, and specifically including the right to file international and foreign national or regional applications and claim priority to this application therefore under the provisions of any convention or treaty;

and I also hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale;

and I further hereby covenant that I will, upon ASSIGNEE'S request, promptly provide ASSIGNEE with all pertinent facts and documents, relating to said application, to any invention disclosed therein, or to any of said Letters Patent or legal equivalents thereof in the United States or in foreign countries, as may be known and accessible to me, and that I will testify and give evidence as to the same in any litigation or interference which may arise, and that I will promptly execute and deliver to ASSIGNEE or its legal representative, without charge but at Assignee's expense, any and all papers, instruments or affidavits which may be required, necessary or desirable for the purpose of applying for, obtaining, maintaining, issuing or enforcing said application and said Letters Patent and said equivalents thereof in the United States or in any foreign country; and I further authorize ASSIGNEE or its legal representative to make any submissions or true declarations which may be needed in connection with the prosecution of this application or related applications in the U.S. or in other countries, consistent with the requirements of the applicable country;

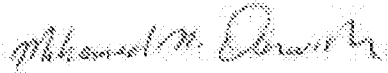
AND I HEREBY AUTHORIZE AND REQUEST the issuing authority to issue any and all United States and foreign national or regional patent documents or grants related to this application and/or invention to ASSIGNEE, its successors and assigns.

IN WITNESS WHEREOF, this Assignment has been executed on the date set forth below.

Inventor: AMIT PAUL

Signature: _____ Date: _____
Residence: Sunnyvale, California

Inventor: MOHAMED N. DARWISH



Signature: _____ Date: 1/5/12
Residence: Campbell, California